Ohmite's TAP800 Series dissipates 800 watts of power when used with a liquid or air cooled heat sink system. The TAP800 rounds out 600 watt (TAP600) and 1000 watt (TAP1000) product offerings. Applications include variable speed drives, power supplies, robotics, motor control, control devices, and other power designs.

FEATURES

- Electric support is high alumina content ceramic metallized on the bottom for ideal heat transfer and optimum discharge.
- Encapsulated with a special resin filled epoxy casing with a large creepage distance to mass, large air distance between terminals, and a high insulation resistance (CTI 600).
- Resistive element is specially designed for low inductance and capacitance. The element provides stable performance in addition to high wattage and pulse loading capability.
- Contacts allow for easy load connecting with M4 or M5 screws (not included).
- Materials meet the requirements of UL94-V0

SPECIFICATIONS

Electrical

Resistance Values: 1Ω to $10K\Omega$ • Resistance Tolerance: $\pm 5\%$ to

- ±10%
 Temperature Coefficient:
 ±150ppm/°C (others upon request)
- Maximum Working Voltage: 5,000V DC, higher voltage on request, not exceeding max. power

- Short Time Overload: 1,200W at 70°C for 10sec., ΔR=0.4% max.
- Power Rating: 800W at 85°C Bottom case temperature.
- Peak Current: up to 1500 amp. depending on pulse length and frequency Please ask for details
- Electric Strength Voltage: 6kVrms, 50Hz,upto 12kVrms on special request.
- Single Shot Voltage: up to 12kV Normwave (1.5/50 μsec)
- Partial Discharge: 4KVrms, <10pC, up to 7kV on special request
- Insulation Resistance: 10GΩ min. at 500V
- Creeping Distance: 42mm min.
- Air Distance: 14mm min.
- Inductance: 80nH
- Capacity/Mass: 110pF
- Capacity/Parallel: 40pF
- Operation Temperature: -55°C to +150°C
- Max. Torque for Contacts: 2 Nm
- Max. Torque for Mounting: 1.8
 Nm M4 screws (not included)

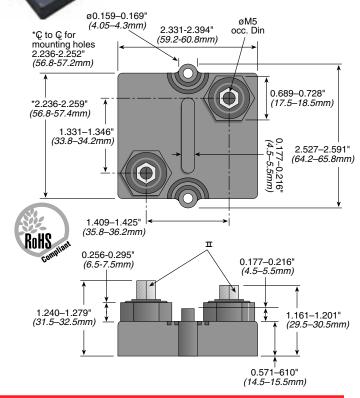
Derating: 8.73W/°K (0.115°K/W)
Power Rating: 800W at 85°C
bottom case temp. This value
is only valid by using a thermal
conduction to the heatsink Rthcs<0.025°K/W. This value can
be reached by using thermal
transfer compound with a heat
conductivity of 1W/mK. The flatness of the cooling plate must be
better than 0.05mm overall. The
roughness of the surface should
not exceed 6.4μm.

STANDARD VALUES

1.0	100	1000
5.0	220	2700
10	390	3000
15	500	5000
50	680	10,000

TAP800 Series

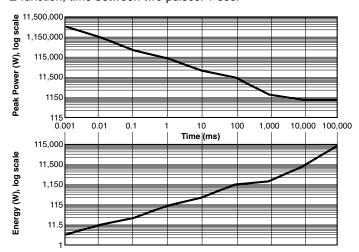
800 Watt Heat Sinkable Planar



PERFORMANCE DATA			
Test	Method	Typical Results - ∆R	
Short time overload	1,000 W/10sec	0.4%	
Humidity Steady State	56 days/40°C/95%	0.25%	
Temp. Cycling	-55/+125/5 cycles	0.20%	
Shock	40g/4,000 times	0.25%	
Vibration	2-500Hz/10g	0.25%	
Load Life	Pn 30 min. on/30 min off,	1,000cyl 0.40%	
Terminal Strength	200N	0.05%	

PULSE-FORMS

E-function, time between two pulses: 1 sec.



DERATING CURVE

